74LVC138A 3-to-8 line decoder/demultiplexer; inverting Rev. 5 – 19 October 2011

Product data sheet

1. General description

The 74LVC138A is a 3-to-8 line decoder/demultiplexer. It accepts three binary weighted address inputs (A0, A1 and A2) and, when enabled, provides eight mutually exclusive outputs ($\overline{Y}0$ to $\overline{Y}7$) that are LOW when selected.

There are three enable inputs: two active LOW ($\overline{E}1$ and $\overline{E}2$) and one active HIGH (E3). Every output will be HIGH unless $\overline{E}1$ and $\overline{E}2$ are LOW and E3 is HIGH.

This multiple enable function allows easy parallel expansion of the device to a 1-of-32 (5 lines to 32 lines) decoder with just four 74LVC138A devices and one inverter. The 74LVC138A can be used as an eight output demultiplexer by using one of the active LOW enable inputs as the data input and the remaining enable inputs as strobes. Unused enable inputs must be permanently tied to their appropriate active HIGH or LOW state.

2. Features and benefits

- 5 V tolerant inputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- Demultiplexing capability
- Multiple input enable for easy expansion
- Ideal for memory chip select decoding
- Mutually exclusive outputs
- Output drive capability 50 Ω transmission lines at 125 °C
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - JESD8-5A (2.3 V to 2.7 V)
 - JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from –40 °C to +85 °C and from –40 °C to +125 °C



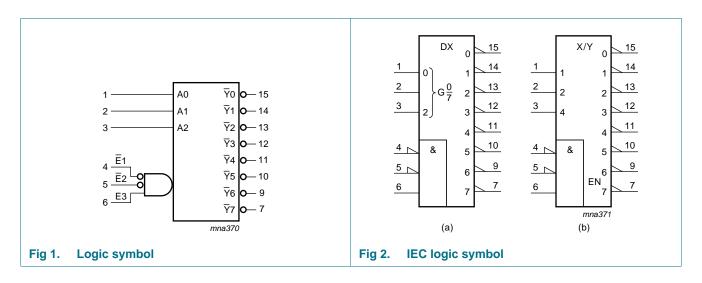
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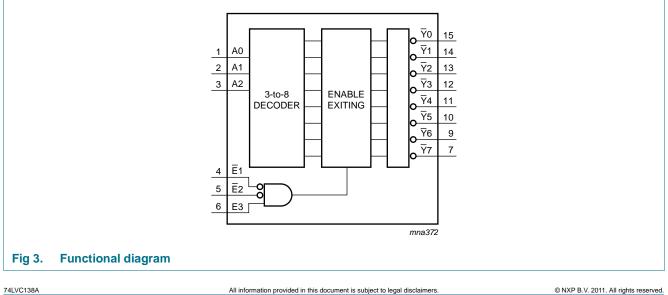
3-to-8 line decoder/demultiplexer; inverting

3. Ordering information

Table 1. Orde	ering information	Table 1. Ordering information								
Type number	Package									
	Temperature range	Name	Description	Version						
74LVC138AD	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1						
74LVC138ADB	–40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1						
74LVC138APW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1						
74LVC138ABQ	–40 °C to +125 °C	DHVQFN16	plastic dual in-line compatible thermal-enhanced very thin quad flat package; no leads; 16 terminals; body $2.5 \times 3.5 \times 0.85$ mm	SOT763-1						

4. Functional diagram

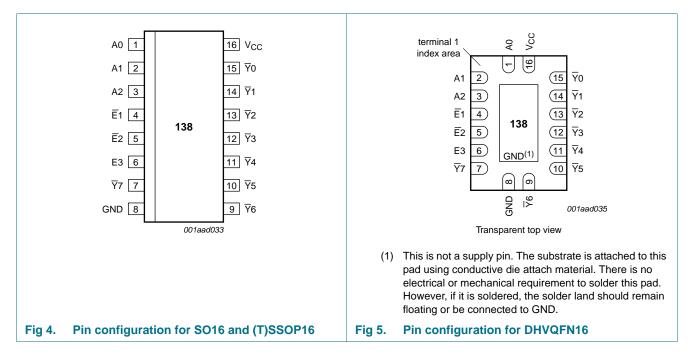




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5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
A0	1	address input
A1	2	address input
A2	3	address input
Ē1	4	enable input (active LOW)
E2	5	enable input (active LOW)
E3	6	enable input (active HIGH)
GND	8	ground (0 V)
<u>Y</u> [0:7]	15, 14, 13, 12, 11, 10, 9, 7	output
V _{CC}	16	supply voltage

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Functional description 6.

nput						Outp	Output					
E1	E2	E3	A0	A1	A2	<u>Y</u> 0	<u></u> 1	<u>Y</u> 2	<u>Y</u> 3	<u>¥</u> 4	<u>¥</u> 5	<u>Y</u> 6
Н	Х	х	Х	х	Х	н	н	Н	н	Н	Н	н
X	Н	Х	Х	Х	Х	Н	Н	Н	Н	Н	Н	Н
X	Х	L	Х	Х	Х	Н	Н	Н	Н	Н	Н	Н
L I	L	Н	L	L	L	L	Н	Н	Н	Н	Н	Н
			Н	L	L	Н	L	Н	Н	Н	Н	Н
			L	Н	L	Н	Н	L	Н	Н	Н	Н
			Н	Н	L	Н	Н	Н	L	Н	Н	Н
			L	L	Н	Н	Н	Н	Н	L	Н	Н
			Н	L	Н	Н	Н	Н	Н	Н	L	Н
			L	Н	Н	Н	Н	Н	Н	Н	Н	L
			Н	Н	Н	Н	Н	Н	Н	Н	Н	Н

[1] HIGH voltage level; L = LOW voltage level; X = don't care

Limiting values 7.

Table 4. **Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V ₁ < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
I _{OK}	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V	-	±50	mA
Vo	output voltage	output HIGH or LOW state	[2] –0.5	V _{CC} + 0.5	V
lo	output current	$V_{O} = 0 V \text{ to } V_{CC}$	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	<u>[3]</u>	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

For SO16 packages: above 70 $^\circ\text{C}$ the value of P_D derates linearly with 8 mW/K. [3]

For (T)SSOP16 packages: above 60 °C the value of P_D derates linearly with 5.5 mW/K. For DHVQFN16 packages: above 60 °C the value of P_D derates linearly with 4.5 mW/K.

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8. Recommended operating conditions

Table 5.	Recommended operating of	conditions				
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
V _{CC} supply voltage			1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW state	0	-	V_{CC}	V
T _{amb}	ambient temperature		-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall	V_{CC} = 1.65 V to 2.7 V	0	-	20	ns/V
	rate	V_{CC} = 2.7 V to 3.6 V	0	-	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	85 °C	-40 °C to	o +125 °C	Unit
			Min	Typ <mark>[1]</mark>	Мах	Min	Max	-
VIH	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V_{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
		V_{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		$V_{CC} = 2.7 V \text{ to } 3.6 V$	-	-	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		I_{O} = -8 mA; V_{CC} = 2.3 V	1.8	-	-	1.65	-	V
		$I_0 = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_O = -24$ mA; $V_{CC} = 3.0$ V	2.2	-	-	2.0	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = 100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	-	-	0.2	-	0.3	V
		$I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_0 = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		$I_0 = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		$I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
I	input leakage current	V_{CC} = 3.6 V; V_{I} = 5.5 V or GND	-	±0.1	±5	-	±20	μΑ

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Symbol	Parameter	Conditions	-4	–40 °C to +85 °C			–40 °C to +125 °C		
			Min	Typ[1]	Max	Min	Max		
I _{CC}	supply current	$V_{CC} = 3.6 \text{ V}; V_I = V_{CC} \text{ or GND};$ $I_O = 0 \text{ A}$	-	0.1	10	-	40	μA	
∆I _{CC}	additional supply current	per input pin; $V_{CC} = 2.7 V \text{ to } 3.6 V;$ $V_I = V_{CC} - 0.6 V; I_O = 0 A$	-	5	500	-	5000	μΑ	
CI	input capacitance	$V_{CC} = 0 V$ to 3.6 V; $V_I = GND$ to V_{CC}	-	4.0	-	-	-	pF	

Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	o +125 °C	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t _{pd}	propagation delay	An to Yn; see Figure 6	[2]						
		V _{CC} = 1.2 V		-	14	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		0.5	5.2	11.5	0.5	12.7	ns
		V_{CC} = 2.3 V to 2.7 V		1.5	3.0	6.5	1.5	7.3	ns
		$V_{CC} = 2.7 V$		1.5	3.2	6.8	1.5	8.5	ns
		V_{CC} = 3.0 V to 3.6 V		1.0	2.7	5.8	1.0	7.5	ns
		E3 to Yn; see Figure 6	[2]						
		V _{CC} = 1.2 V		-	14	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		1.0	5.5	11.4	1.0	12.5	ns
		V_{CC} = 2.3 V to 2.7 V		1.5	3.2	6.5	1.5	7.1	ns
		$V_{CC} = 2.7 V$		1.5	3.3	6.8	1.5	8.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	2.9	5.8	1.0	7.5	ns
		En to Yn; see Figure 7	[2]						
		$V_{CC} = 1.2 V$		-	15	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V		1.0	5.6	11.5	1.0	12.8	ns
		V_{CC} = 2.3 V to 2.7 V		1.8	3.3	6.5	1.8	7.3	ns
		$V_{CC} = 2.7 V$		1.5	3.4	6.4	1.5	8.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	2.9	5.8	1.0	7.5	ns
t _{sk(o)}	output skew time		[3]	-	-	1.0	-	1.5	ns

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Symbol	Parameter	Conditions	−40 °C to +85 °C		5 °C	−40 °C to +125 °C		Unit	
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
· - ·	power dissipation	$V_I = GND$ to V_{CC}	[4]						
	capacitance	V_{CC} = 1.65 V to 1.95 V		-	9.9	-			pF
		V_{CC} = 2.3 V to 2.7 V		-	15.8	-			pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	21.1	-			pF

Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see <u>Figure 8</u>.

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz; f_o = output frequency in MHz

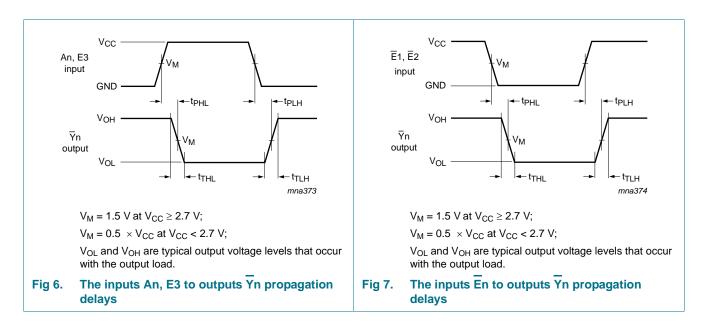
 C_L = output load capacitance in pF

V_{CC} = supply voltage in V

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs

11. Waveforms



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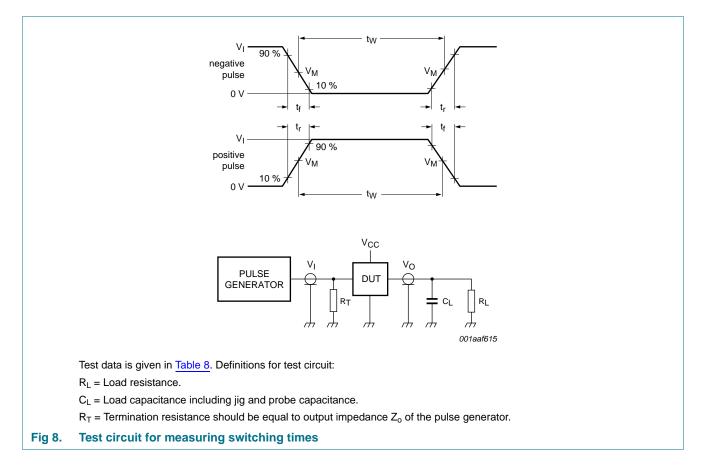


Table 8. Test data

Supply voltage	Input		Load		
	VI	t _r , t _f	CL	RL	
1.2 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	
1.65 V to 1.95 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	
2.3 V to 2.7 V	V _{CC}	\leq 2 ns	30 pF	500 Ω	
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	
3.0 V to 3.6 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	

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12. Package outline

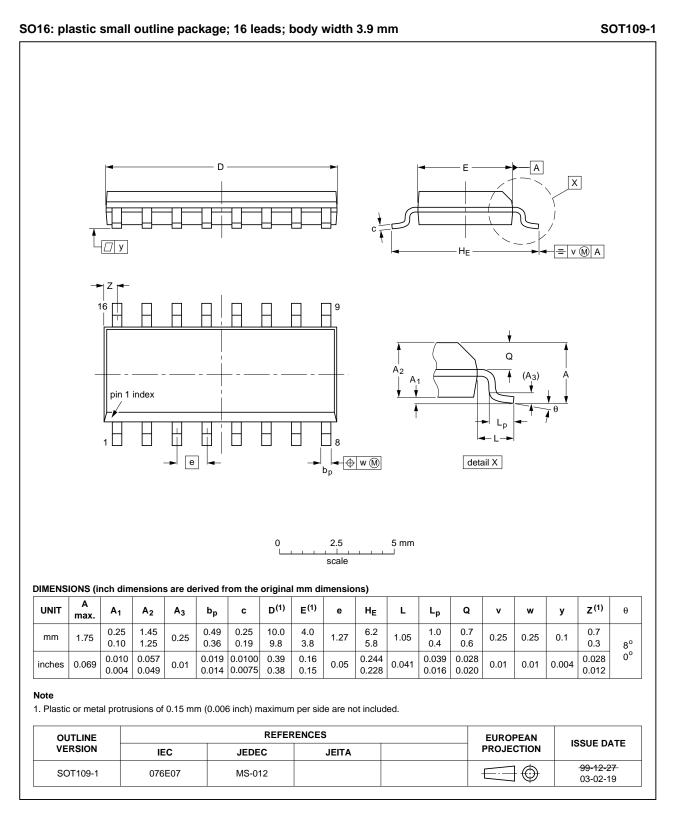


Fig 9. Package outline SOT109-1 (SO16)

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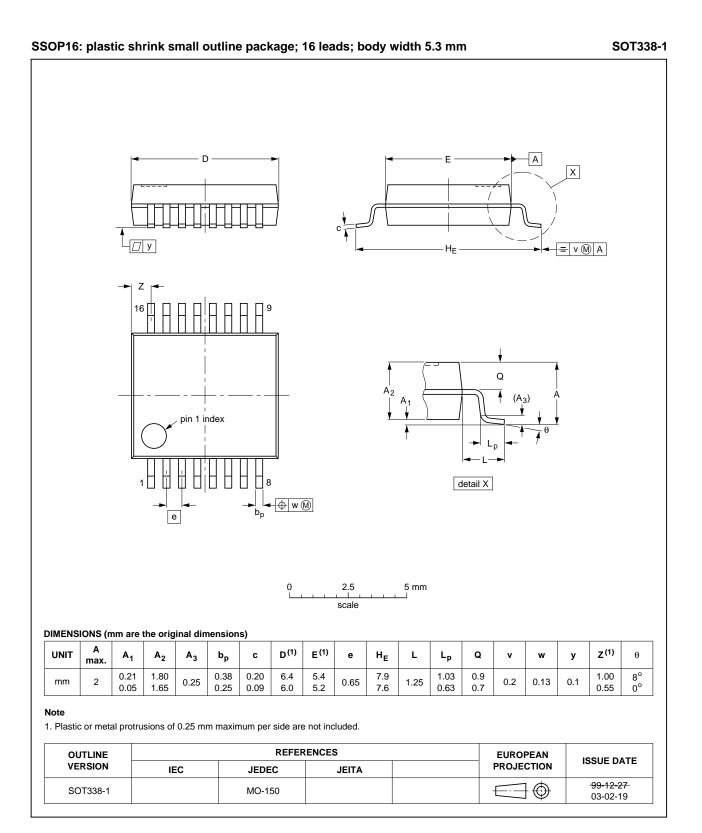


Fig 10. Package outline SOT338-1 (SSOP16)

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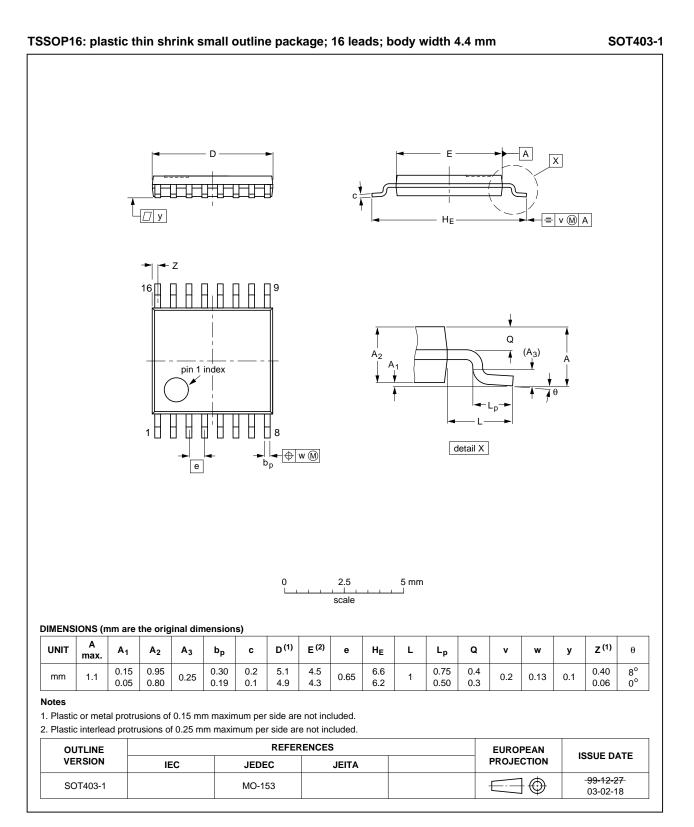
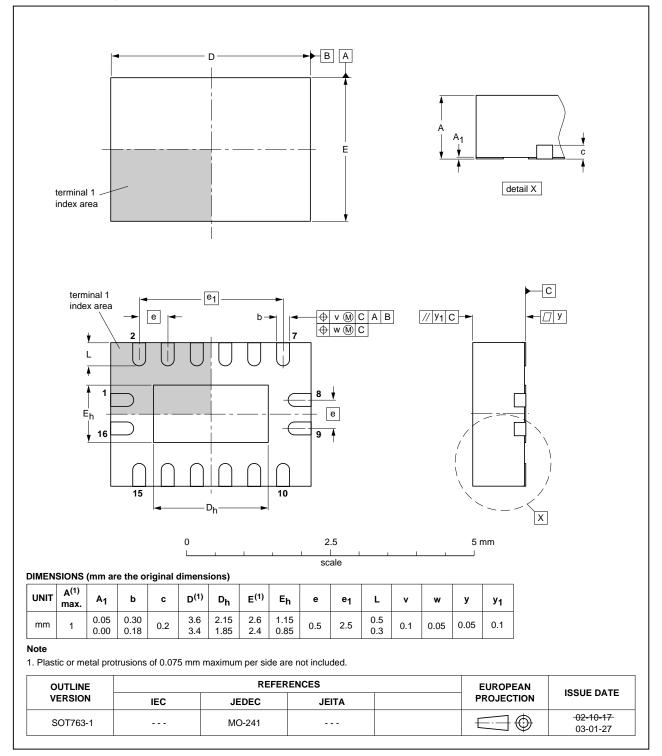


Fig 11. Package outline SOT403-1 (TSSOP16)

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DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

Fig 12. Package outline SOT763-1 (DHVQFN16)

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13. Abbreviations

Table 9.	Abbreviations
Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 10. Revision history									
Document ID	Release date	Data sheet status	Change notice	Supersedes					
74LVC138A v.5	20111019	Product data sheet	-	74LVC138A v.4					
Modifications:	of NXP Semicondu		•						
	 Legal texts have be 	een adapted to the new co	ompany name where app	propriate.					
	• <u>Table 4, Table 5, Ta</u>	able 6, Table 7 and Table	8: values added for lower	r voltage ranges.					
74LVC138A v.4	20030506	Product specification	-	74LVC138A v.3					
74LVC138A v.3	20020312	Product specification	-	74LVC138A v.2					
74LVC138A v.2	19980428	Product specification	-	74LVC138A v.1					
74LVC138A v.1	-	-	-	-					

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15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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